

# Silicon Carbide (SiC) MOSFET – 160 mohm, 1200 V, M1, TO-247-3L

## NVHL160N120SC1

### Features

- Typ.  $R_{DS(on)} = 160\text{ m}\Omega$
- Ultra Low Gate Charge (typ.  $Q_{G(tot)} = 34\text{ nC}$ )
- Low Effective Output Capacitance (typ.  $C_{oss} = 50\text{ pF}$ )
- 100% UIL Tested
- AEC-Q101 Qualified and PPAP Capable
- This Device is Halide Free and RoHS Compliant with exemption 7a, Pb-Free 2LI (on second level interconnection)

### Typical Applications

- Automotive On Board Charger
- Automotive DC-DC Converter for EV/HEV

### MAXIMUM RATINGS ( $T_J = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-to-Source Voltage	$V_{DSS}$	1200	V
Gate-to-Source Voltage	$V_{GS}$	-15/+25	V
Recommended Operation Values of Gate-to-Source Voltage	$T_C < 175^\circ\text{C}$ $V_{GSop}$	-5/+20	V
Continuous Drain Current	Steady State $T_C = 25^\circ\text{C}$ $I_D$	17	A
Power Dissipation	$P_D$	119	W
Continuous Drain Current	Steady State $T_C = 100^\circ\text{C}$ $I_D$	12	A
Power Dissipation	$P_D$	59	W
Pulsed Drain Current (Note 2)	$T_A = 25^\circ\text{C}$ $I_{DM}$	69	A
Single Pulse Surge Drain Current Capability	$T_A = 25^\circ\text{C}$ , $t_p = 10\text{ }\mu\text{s}$ , $R_G = 4.7\text{ }\Omega$ $I_{DSC}$	140	A
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55 to +175	$^\circ\text{C}$
Source Current (Body Diode)	$I_S$	11	A
Single Pulse Drain-to-Source Avalanche Energy ( $I_{L(pk)} = 23\text{ A}$ , $L = 1\text{ mH}$ ) (Note 3)	$E_{AS}$	128	mJ

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

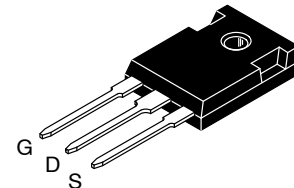
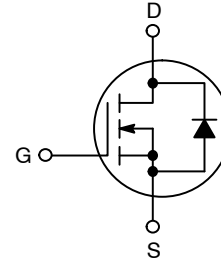
### THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Junction-to-Case (Note 1)	$R_{\theta JC}$	1.3	$^\circ\text{C/W}$
Junction-to-Ambient (Note 1)	$R_{\theta JA}$	40	$^\circ\text{C/W}$

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
2. Repetitive rating, limited by max junction temperature.
3.  $E_{AS}$  of 128 mJ is based on starting  $T_J = 25^\circ\text{C}$ ;  $L = 1\text{ mH}$ ,  $I_{AS} = 16\text{ A}$ ,  $V_{DD} = 120\text{ V}$ ,  $V_{GS} = 18\text{ V}$ .

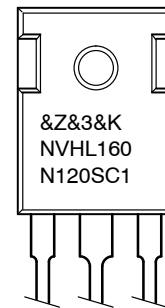
$V_{(BR)DSS}$	$R_{DS(on)}\text{ MAX}$	$I_D\text{ MAX}$
1200 V	224 m $\Omega$ @ 20 V	17 A

### N-CHANNEL MOSFET



TO-247-3LD  
CASE 340CX

### MARKING DIAGRAM



&Z = Assembly Plant Code  
&3 = Date Code (Year & Week)  
&K = Lot  
NVHL160N120SC1 = Specific Device Code

### ORDERING INFORMATION

Device	Package	Shipping
NVHL160N120SC1	TO247-3L	30 Units / Tube

# NVHL160N120SC1

## ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25°C unless otherwise stated)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
-----------	--------	-----------------	-----	-----	-----	------

### OFF CHARACTERISTICS

Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA	1200	-	-	V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> /T <sub>J</sub>	I <sub>D</sub> = 1 mA, referenced to 25°C	-	600	-	mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 1200 V, T <sub>J</sub> = 25°C	-	-	100	μA
		V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 1200 V, T <sub>J</sub> = 175°C	-	-	250	
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = +25/-15 V, V <sub>DS</sub> = 0 V	-	-	±1	μA

### ON CHARACTERISTICS

Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 2.5 mA	1.8	3.1	4.3	V
Recommended Gate Voltage	V <sub>GOP</sub>		-5	-	+20	V
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 20 V, I <sub>D</sub> = 12 A, T <sub>J</sub> = 25°C	-	162	224	mΩ
		V <sub>GS</sub> = 20 V, I <sub>D</sub> = 12 A, T <sub>J</sub> = 175°C	-	271	377	
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 12 A	-	3	-	S

### CHARGES, CAPACITANCES & GATE RESISTANCE

Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> = 0 V, f = 1 MHz, V <sub>DS</sub> = 800 V	-	665	-	pF
Output Capacitance	C <sub>OSS</sub>		-	50	-	
Reverse Transfer Capacitance	C <sub>RSS</sub>		-	5	-	
Total Gate Charge	Q <sub>G(tot)</sub>	V <sub>GS</sub> = -5/20 V, V <sub>DS</sub> = 600 V, I <sub>D</sub> = 16 A	-	34	-	nC
Threshold Gate Charge	Q <sub>G(th)</sub>		-	6	-	
Gate-to-Source Charge	Q <sub>GS</sub>		-	12.5	-	
Gate-to-Drain Charge	Q <sub>GD</sub>		-	9.6	-	
Gate Resistance	R <sub>G</sub>		f = 1 MHz	-	1.4	

### SWITCHING CHARACTERISTICS

Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>GS</sub> = -5/20 V, V <sub>DS</sub> = 800 V, I <sub>D</sub> = 16 A, R <sub>G</sub> = 6 Ω, Inductive Load	-	11	-	ns	
Rise Time	t <sub>r</sub>		-	19	-		
Turn-Off Delay Time	t <sub>d(off)</sub>		-	15	-		
Fall Time	t <sub>f</sub>		-	8	-		
Turn-On Switching Loss	E <sub>ON</sub>			-	200	-	μJ
Turn-Off Switching Loss	E <sub>OFF</sub>			-	34	-	
Total Switching Loss	E <sub>TOT</sub>			-	234	-	

### DRAIN-SOURCE DIODE CHARACTERISTICS

Continuous Drain-to-Source Diode Forward Current	I <sub>SD</sub>	V <sub>GS</sub> = -5 V, T <sub>J</sub> = 25°C	-	-	11	A
Pulsed Drain-to-Source Diode Forward Current (Note 2)	I <sub>SDM</sub>	V <sub>GS</sub> = -5 V, T <sub>J</sub> = 25°C	-	-	69	A
Forward Diode Voltage	V <sub>SD</sub>	V <sub>GS</sub> = -5 V, I <sub>SD</sub> = 6 A, T <sub>J</sub> = 25°C	-	4	10	V
Reverse Recovery Time	t <sub>RR</sub>	V <sub>GS</sub> = -5/20 V, I <sub>SD</sub> = 16 A, dI <sub>S</sub> /dt = 1000 A/μs	-	15	-	ns
Reverse Recovery Charge	Q <sub>RR</sub>		-	45	-	nC
Reverse Recovery Energy	E <sub>REC</sub>		-	3.9	-	μJ
Peak Reverse Recovery Current	I <sub>RPM</sub>		-	6.2	-	A
Charge Time	T <sub>a</sub>		-	7.4	-	ns
Discharge Time	T <sub>b</sub>		-	7	-	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

# NVHL160N120SC1

## TYPICAL CHARACTERISTICS

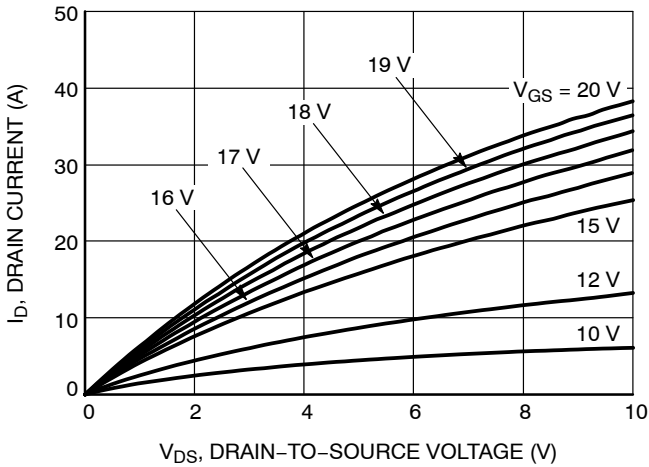


Figure 1. On-Region Characteristics

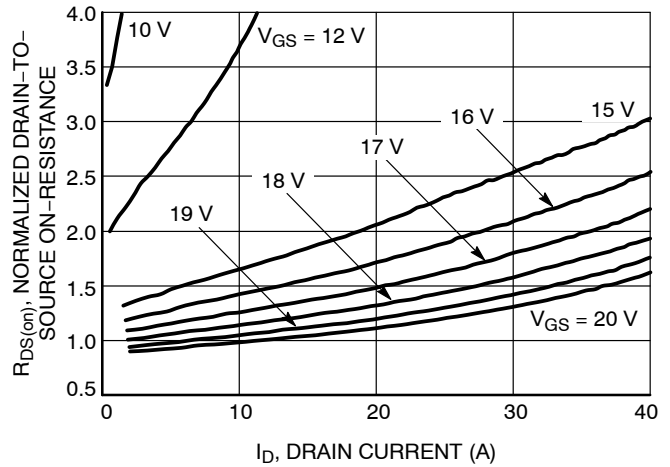


Figure 2. Normalized On-Resistance vs. Drain Current and Gate Voltage

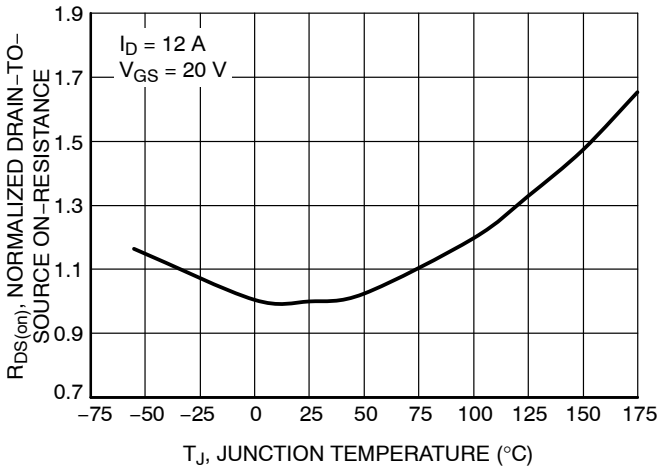


Figure 3. On-Resistance Variation with Temperature

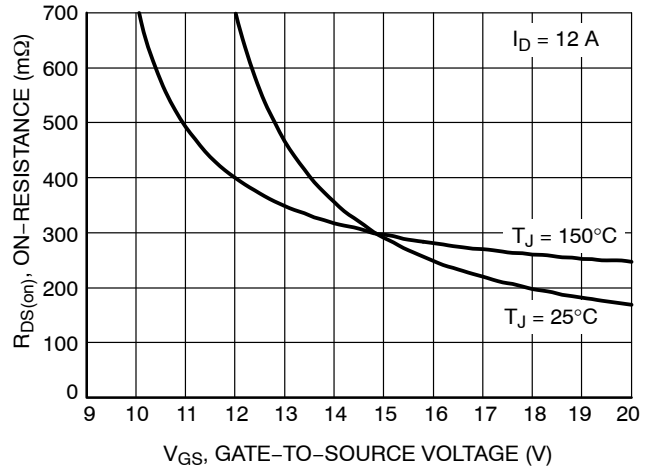


Figure 4. On-Resistance vs. Gate-to-Source Voltage

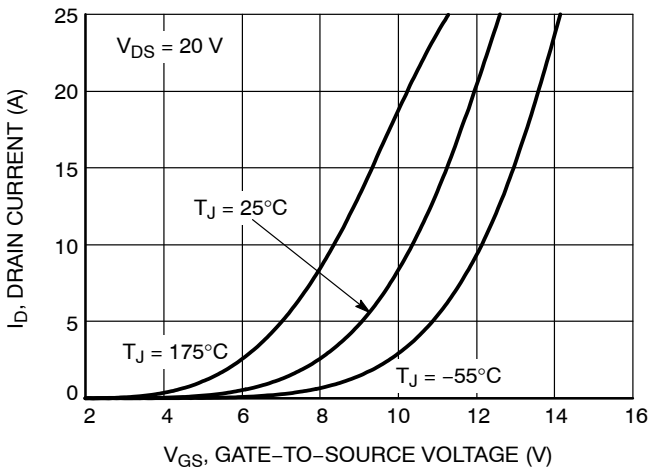


Figure 5. Transfer Characteristics

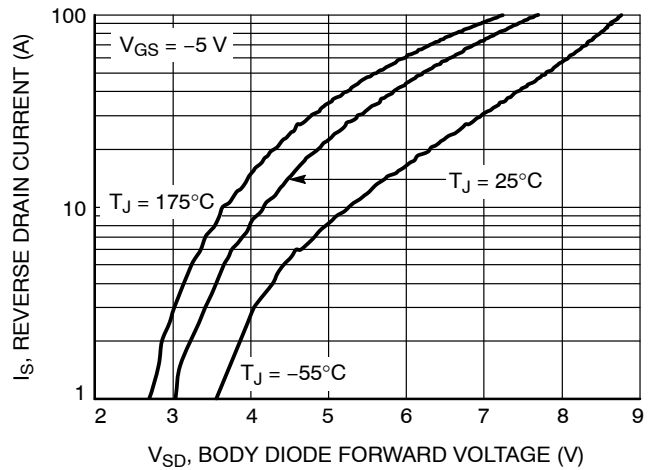
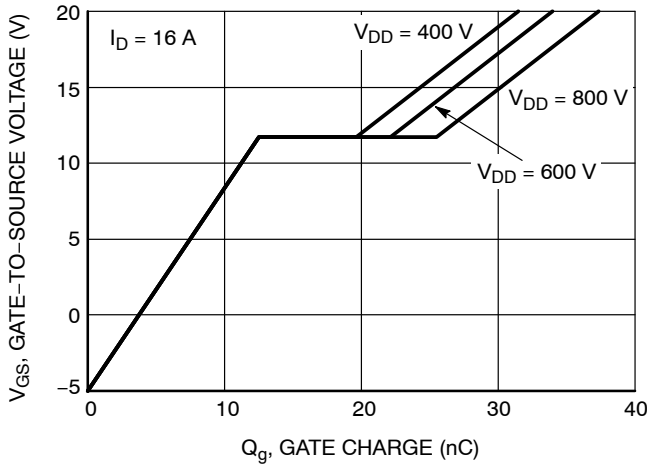


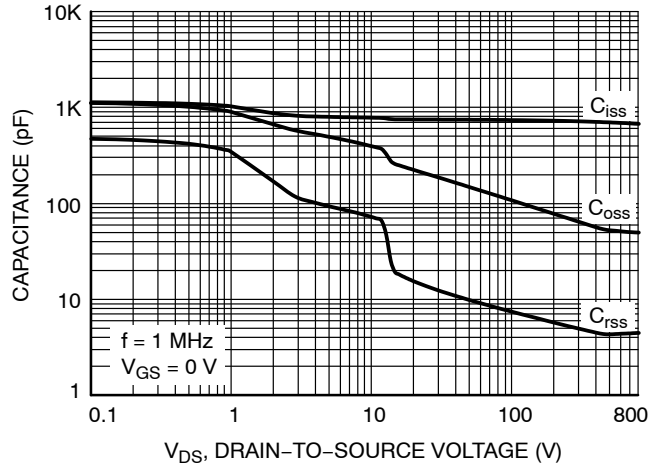
Figure 6. Diode Forward Voltage vs. Current

# NVHL160N120SC1

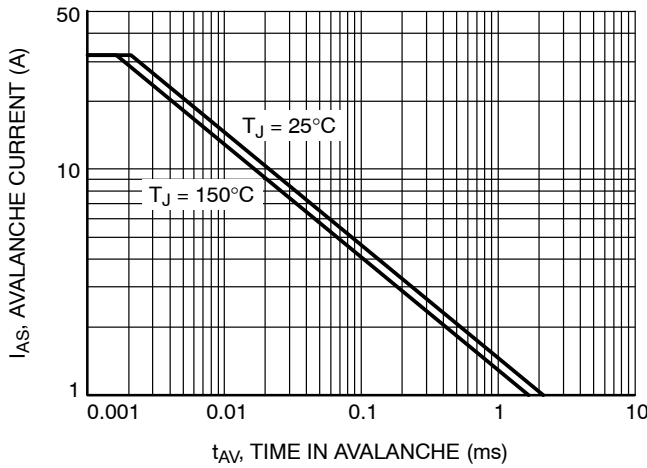
## TYPICAL CHARACTERISTICS (continued)



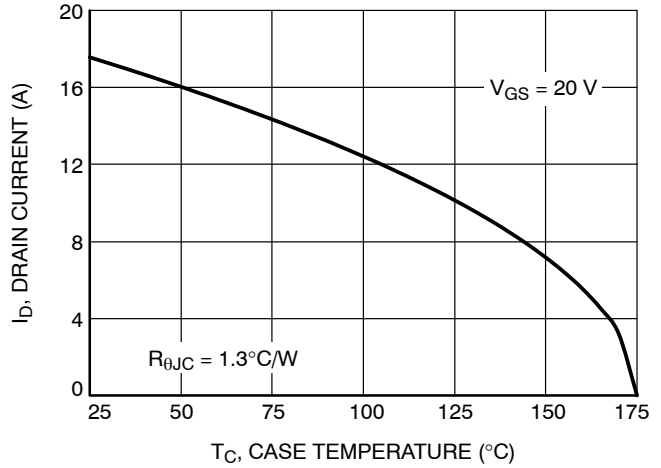
**Figure 7. Gate-to-Source Voltage vs. Total Charge**



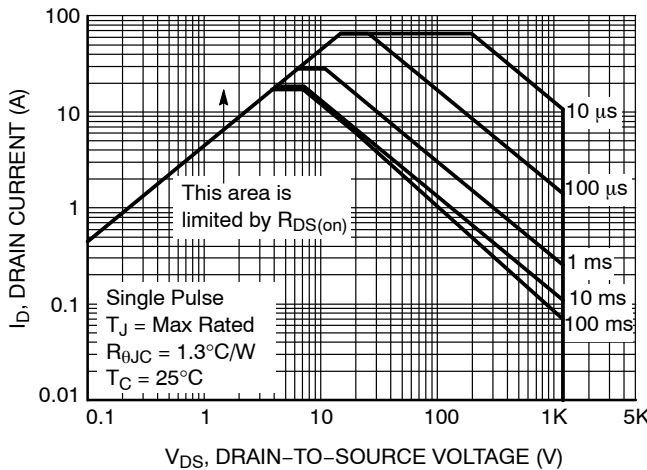
**Figure 8. Capacitance vs. Drain-to-Source Voltage**



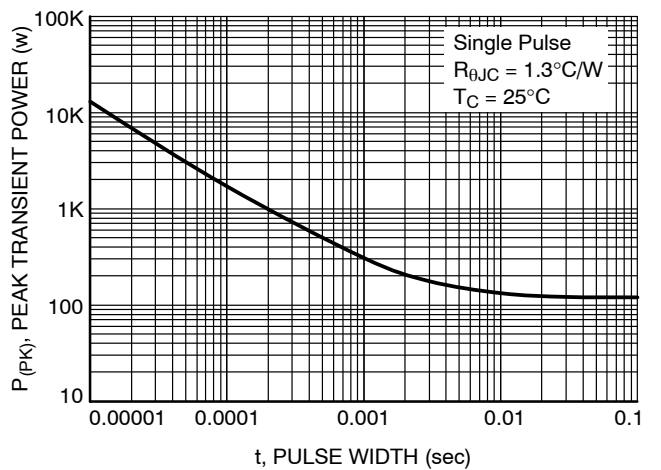
**Figure 9. Unclamped Inductive Switching Capability**



**Figure 10. Maximum Continuous Drain Current vs. Case Temperature**



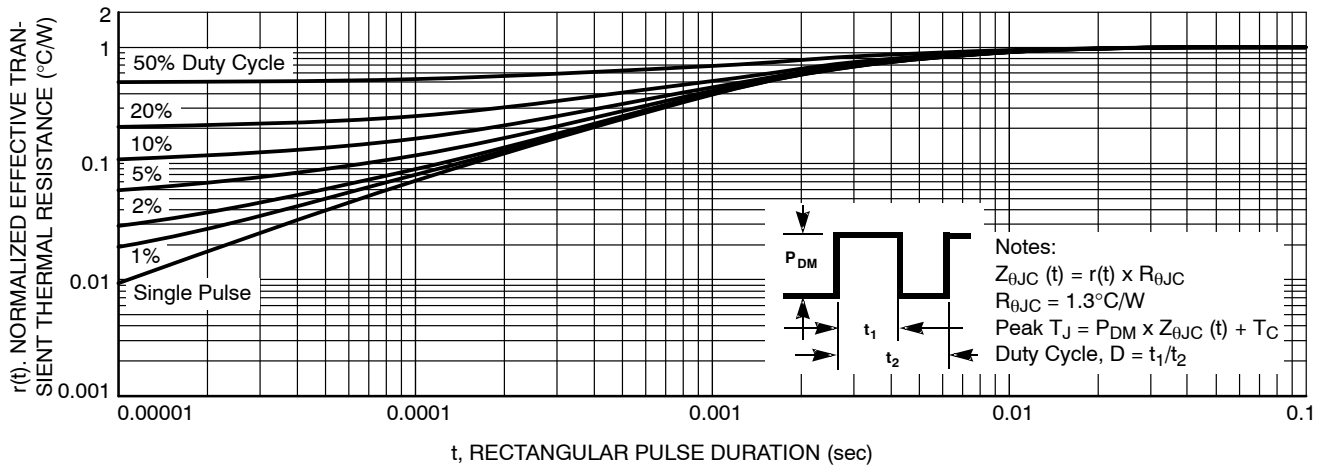
**Figure 11. Safe Operating Area**



**Figure 12. Single Pulse Maximum Power Dissipation**

# NVHL160N120SC1

## TYPICAL CHARACTERISTICS (continued)



**Figure 13. Junction-to-Ambient Thermal Response**



**onsemi**, **Onsemi**, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "**onsemi**" or its affiliates and/or subsidiaries in the United States and/or other countries. **onsemi** owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of **onsemi**'s product/patent coverage may be accessed at [www.onsemi.com/site/pdf/Patent-Marking.pdf](http://www.onsemi.com/site/pdf/Patent-Marking.pdf). **onsemi** reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and **onsemi** makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

## ADDITIONAL INFORMATION

### TECHNICAL PUBLICATIONS:

Technical Library: [www.onsemi.com/design/resources/technical-documentation](http://www.onsemi.com/design/resources/technical-documentation)  
onsemi Website: [www.onsemi.com](http://www.onsemi.com)

### ONLINE SUPPORT: [www.onsemi.com/support](http://www.onsemi.com/support)

For additional information, please contact your local Sales Representative at [www.onsemi.com/support/sales](http://www.onsemi.com/support/sales)